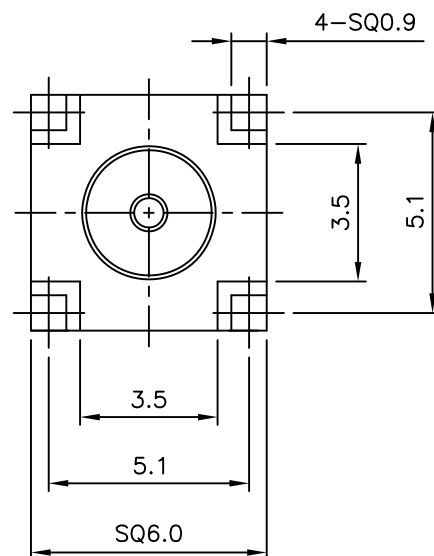
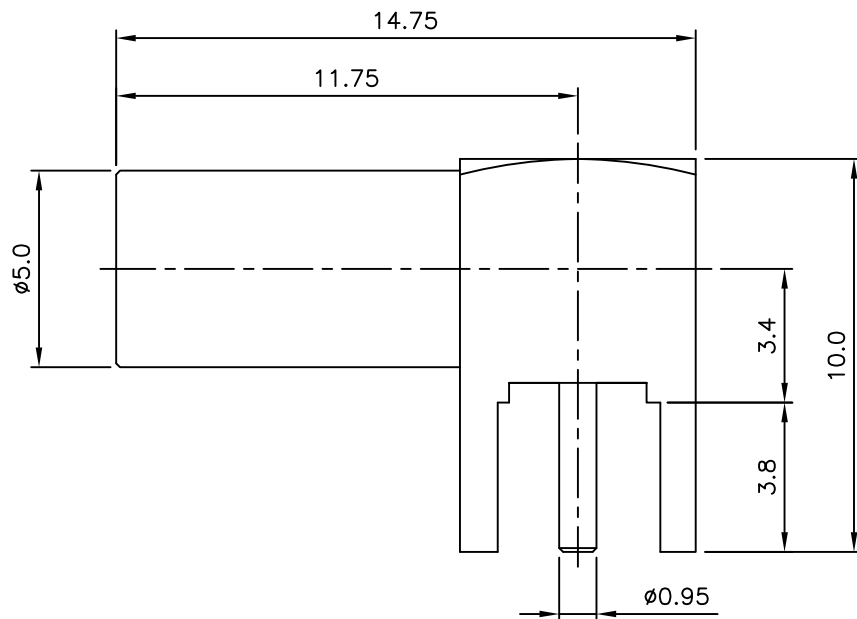
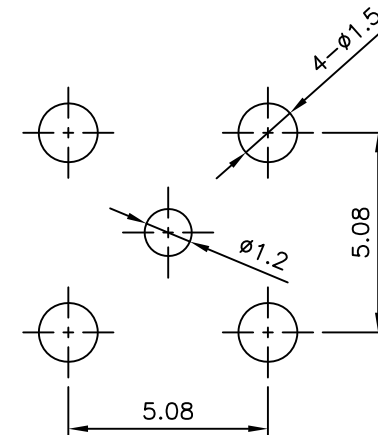




REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2021.06.08.
1	[설번No.202201-0005] 억지끼움 조립성 개선으로 인한 바디 가이드부 치수 변경	S.Y.EUN	S.H.KIM	2022.01.07.



PCB MOUNTING HOLE SIZE

5	INSULATOR	1	TEFLON		DIN03221-N/2
4	INSULATOR	1	TEFLON		DIN03227-N/1
3	CONTACT	1	BeCu C17300	Gold Plate	DCT04223-5/1
2	JACK BODY	1	MBsBD C3604BD-F	Nickel Plate	DBD04744-5/1
1	사각 BODY	1	MBsBD C3604BD-F	Nickel Plate (납땜성향상)	DBD04743-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017			
	±0.1	2022. 01. 07.					
Angle		APPROVED BY	S.H.KIM		KJ COMTECH CO.,LTD.		
	±1°	CHECKED BY					
MATERIAL		DRAWN BY		TITLE			
		S.Y.EUN		MCX50 PCB JL-4R			
FINISH		SCALE	UNIT		A4		
		5/1	mm			DWG NO.	CN03998-7/1
				REVISION	1	SHEET	1 of 1